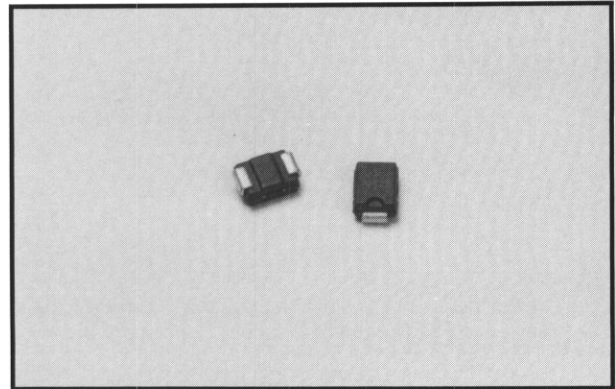


B220 Thru B260



2 AMP SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER



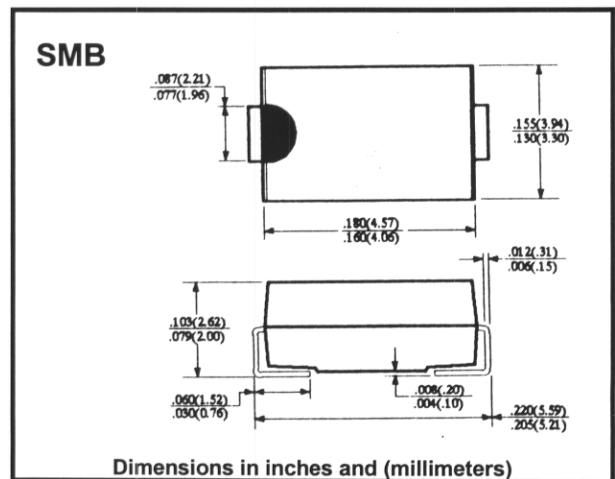
FEATURES

- For surface mount applications
- Metal semiconductor junction with guard ring
- Epitaxial construction
- Low forward voltage drop
- UL recognized 94V-O plastic material
- Lead solderable per MIL-STD-202 Method 208
- Surge overload rating to 50A peak

Mechanical Data

- Case: Molded plastic
- Polarity: Indicated on cathode
- Weight: 0.003 ounces, 0.093 grams

Outline Drawing



Maximum Ratings & Characteristics

- Ratings at 25° C ambient temperature unless otherwise specified
- Single phase, half wave, 60Hz, resistive or inductive load
- For capacitive load, derate current by 20%

		B220	B230	B240	B250	B260	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	20	30	40	50	60	V
Maximum RMS Input Voltage	V_{RMS}	14	21	28	35	42	V
Maximum DC Blocking Voltage	V_{DC}	20	30	40	50	60	V
Maximum Average Forward Output Current .375" 9.5mm lead length @ $T_L = 100^\circ\text{C}$	$I_{(AV)}$	2.0					A
Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave Superimposed On Rated Load	I_{FSM}	50					A
Maximum Forward Voltage Drop At 2.0A	V_F	0.50			0.70		V
Maximum Reverse Current At Rated DC Blocking Voltage per Bridge Element @ $T_A = 25^\circ\text{C}$ @ $T_A = 100^\circ\text{C}$	I_R	0.5			20		mA mA
Typical Junction Capacitance* (See Note)	C_J	200					pF
Maximum Thermal Resistance** (See Note)	$R_{(THJL)}$	20					$^\circ\text{C}/\text{W}$
Operating Temperature Range	T_J	-65 to +125					$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to +150					$^\circ\text{C}$

Note: *Measured at 1.0 MHz and applied reverse voltage of 4.0V DC

**Thermal resistance junction to lead, measured on PC board 5mm² X (0.013mm thick)